

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Byoung Hwa LEE</td><td>06/26/2008</td></tr><tr><td>Sung Kwon WI</td><td>06/26/2008</td></tr><tr><td>Hae Suk CHUNG</td><td>06/26/2008</td></tr><tr><td>Dong Seok PARK</td><td>06/26/2008</td></tr><tr><td>Sang Soo PARK</td><td>06/26/2008</td></tr><tr><td>Min Cheol PARK</td><td>06/26/2008</td></tr></tbody></table>	Name	Execution Date	Byoung Hwa LEE	06/26/2008	Sung Kwon WI	06/26/2008	Hae Suk CHUNG	06/26/2008	Dong Seok PARK	06/26/2008	Sang Soo PARK	06/26/2008	Min Cheol PARK	06/26/2008	
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Min Cheol PARK	06/26/2008														
RECEIVING PARTY DATA															
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.														
Street Address:	314 Maetan3-Dong, Yeongtong-Gu														
City:	Suwon, Gyunggi-do, REPUBLIC OF KOREA														
State/Country:	REPUBLIC OF KOREA														
PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12195015</td></tr></tbody></table>	Property Type	Number	Application Number:	12195015											
Property Type	Number														
Application Number:	12195015														
CORRESPONDENCE DATA															
Fax Number:	(202)756-8087														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
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ATTORNEY DOCKET NUMBER:	069576-0400														
NAME OF SUBMITTER:	Stephen A. Becker														
Total Attachments: 3 source=400ASSIGN#page1.tif															

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PATENT
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RECORDATION FORM COVER SHEET

Docket No.: 069576-0400

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Byoung Hwa LEE, Sung Kwon WI, Hae Suk CHUNG, Dong Seok PARK, Sang Soo PARK, Min Cheol PARK

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): **June 26, 2008**

- | | |
|---|---|
| <input checked="" type="checkbox"/> Assignment | <input type="checkbox"/> Merger |
| <input type="checkbox"/> Security Agreement | <input type="checkbox"/> Change of Name |
| <input type="checkbox"/> Joint Research Agreement | |
| <input type="checkbox"/> Government Interest Assignment | |
| <input type="checkbox"/> Executive Order 9424, Confirmatory License | |
| <input type="checkbox"/> Other | |

2. Name and address of receiving party(ies)

Name: **SAMSUNG ELECTRO-MECHANICS CO., LTD.**

Internal Address:

Address: **314 Maetan3-Dong, Yeongtong-Gu, Suwon, Gyunggi-do, REPUBLIC OF KOREA**

Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application or patent number(s):

A. Patent Application No(s).

☒ This document is being filed together with a new application.

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: **MCDERMOTT WILL & EMERY LLP**

Internal Address:

Street Address: **600 13th Street, N.W.**

City: **Washington** State: **D. C.** Zip: **20005-3096**

Phone Number: **202.756.8000**

Fax Number: **202.756.8087**

Email Address:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
- ☒ Authorized to be charged to deposit account
- ☐ Enclosed
- ☐ None required (government interest not affecting title)

8. Payment Information:

- a. Credit Card Last 4 Numbers _____
- Expiration Date _____
- b. Deposit Account Number **500417**
- Authorized User Name _____

9. Signature.

Stephen A. Becker 26,527



August 20, 2008

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: **3**

(SAB)

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>LEE, Byoung Hwa</u>	(5) <u>PARK, Sang Soo</u>
(2) <u>WI, Sung Kwon</u>	(6) <u>PARK, Min Cheol</u>
(3) <u>CHUNG, Hae Suk</u>	(7) _____
(4) <u>PARK, Dong Seok</u>	(8) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto
SAMSUNG ELECTRO-MECHANICS CO., LTD.

314 Maetan3-Dong, Yeongtong-Gu, Suwon, Gyunggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

MULTILAYER CHIP CAPACITOR AND CIRCUIT BOARD DEVICE

INCLUDING THE SAME

(a) for which an application for United States Letters Patent was filed on _____,
and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____,


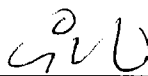
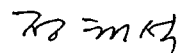
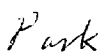
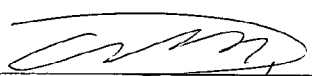
and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

1) <u></u> Name: LEE, Byoung Hwa	<u>2008. 06. 26</u>
2) <u></u> Name: WI, Sung Kwon	<u>2008. 6. 26</u>
3) <u></u> Name: CHUNG, Hae Suk	<u>2008. 6. 26</u>
4) <u></u> Name: PARK, Dong Seok	<u>2008. 06. 26</u>
5) <u></u> Name: PARK, Sang Soo	<u>2008. 06. 26</u>

6)

Sh MM

2008. 8. 26

Name: PARK, Min Cheol